

PART NUMBER

LM307J-ROCV

Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All re-creations are done with the approval of the Original Component Manufacturer. (OCM)

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceeds the OCM data sheet.

Quality Overview

- · ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-38535
 - · Class Q Military
 - · Class V Space Level

Qualified Suppliers List of Distributors (QSLD)

 Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

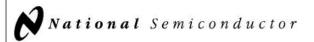
The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OCM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

LM107,LM207,LM307

LM107 LM207 LM307 Operational Amplifiers



Literature Number: SNOSBS4A



LM107/LM207/LM307 Operational Amplifiers

General Description

The LM107 series are complete, general purpose operational amplifiers, with the necessary frequency compensation built into the chip. Advanced processing techniques make the input currents a factor of ten lower than industry standards like the 709. Yet, they are a direct, plug-in replacement for the 709, LM101A and 741.

The LM107 series offers the features of the LM101A, which makes its application nearly foolproof. In addition, the device provides better accuracy and lower noise in high impedance circuitry. The low input currents also make it particularly well suited for long interval integrators or timers, sample and hold circuits and low frequency waveform generators. Further, replacing circuits where matched transistor pairs buffer the inputs of conventional IC op amps, it can give lower offset voltage and drift at a lower cost.

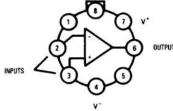
The LM107 is guaranteed over a -55°C to +125°C temperature range, the LM207 from -25°C to $+85^{\circ}\text{C}$ and the LM307 from 0°C to +70°C.

Features

- Offset voltage 3 mV maximum over temperature
- Input current 100 nA maximum over temperature
- Offset current 20 nA maximum over temperature
- Guaranteed drift characteristics

Connection Diagrams





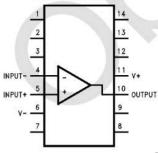
TL/H/7757-2

Note: Pin 4 connected to case

Top View

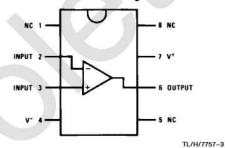
Order Number LM107H/883* See NS Package Number H08C

Dual-in-Line Package



Order Number LM107J-14/883* See NS Package Number J14A

Dual-in-Line Package



Top View Order Number LM107J/883* or LM207J See NS Package Number J08A

> Order Number LM307N See NS Package Number N08A

*Available per SMD# 5962-8958901.

Absolute Maximum Ratings

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/
Distributors for availability and specifications.
(Note 4)

	LM107/LM207	LM307				
Supply Voltage	±22V	±18V		-	+	
Power Dissipation (Note 1)	500 mW	500 mW		TMIN	TMAX	
Differential Input Voltage	rential Input Voltage ±30V		LM107	−55°C	+125°C	
Input Voltage (Note 2)	±15V	±15V	LM207	-25°C	+85°C	
Output Short Circuit Duration	Continuous	Continuous	LM307	0°C	+70°C	
Operating Temperature Range (TA)			ESD rating to be determined.			

(LM207) $-25^{\circ}\text{C to} + 85^{\circ}\text{C}$

Storage Temperature Range -65° C to $+150^{\circ}$ C -65° C to $+150^{\circ}$ C Lead Temperature (Soldering, 10 sec) 260°C 260°C

Electrical Characteristics (Note 3)

Parameter	Conditions	LM107/LM207			LM307			Units
		Min	Тур	Max	Min	Тур	Max	Units
Input Offset Voltage	$T_{A}=$ 25°C, $R_{S}\leq$ 50 k Ω		0.7	2.0		2.0	7.5	mV
Input Offset Current	T _A = 25°C		1.5	10		3.0	50	nA
Input Bias Current	T _A = 25°C		30	75	4	70	250	nA
Input Resistance	T _A = 25°C	1.5	4.0		0.5	2.0		МΩ
Supply Current	$T_A = 25^{\circ}C$ $V_S = \pm 20V$ $V_S = \pm 15V$		1.8	3.0	Y	1.8	3.0	mA mA
Large Signal Voltage Gain	$T_{A}=25^{\circ}\text{C},V_{S}=\pm15\text{V} \ V_{OUT}=\pm10\text{V},R_{L}\geq2k\Omega$	50	160		25	160		V/m\
Input Offset Voltage	$R_S \leq 50 \ k\Omega$			3.0			10	mV
Average Temperature Coefficient of Input Offset Voltage			3.0	15		6.0	30	μ٧/°(
Input Offset Current				20			70	nA
Average Temperature Coefficient of Input Offset Current	$25^{\circ}\text{C} \le \text{T}_{\text{A}} \le \text{T}_{\text{MAX}}$ $\text{T}_{\text{MIN}} \le \text{T}_{\text{A}} \le 25^{\circ}\text{C}$		0.01 0.02	0.1 0.2		0.01 0.02	0.3 0.6	nA/°(nA/°(
Input Bias Current		70)		100			300	nA
Supply Current	$T_A = +125$ °C, $V_S = \pm 20V$	10	1.2	2.5				mA

Electrical Characteristics (Note 3) (Continued)

Parameter	Conditions	LM107/LM207			LM307			Units
		Min	Тур	Max	Min	Тур	Max	Units
Large Signal Voltage Gain	$V_S = \pm 15V, V_{OUT} = \pm 10V$ $R_L \ge 2 k\Omega$	25			15			V/mV
Output Voltage Swing	$V_S = \pm 15V$ $R_L = 10 \text{ k}\Omega$ $R_L = 2 \text{ k}\Omega$	±12 ±10	±14 ±13		±12 ±10	±14 ±13		v v
Input Voltage Range	$V_S = \pm 20V$ $V_S = \pm 15V$	±15	+ 15 - 13		±12	+15 -13		v v
Common Mode Rejection Ratio	$R_S \le 50 \text{ k}\Omega$	80	96		70	90		dB
Supply Voltage Rejection Ratio	$R_S \le 50 \text{ k}\Omega$	80	96		70	96		dB

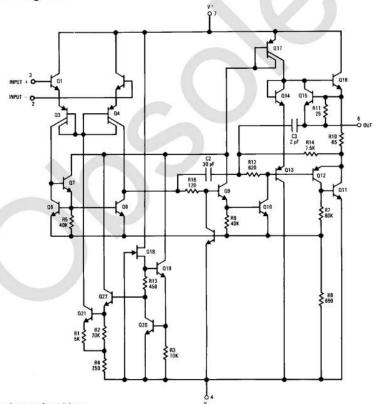
Note 1: The maximum junction temperature of the LM107 is 150°C, and the LM207/LM307 is 100°C. For operating at elevated temperatures, devices in the H08 package must be derated based on a thermal resistance of 165°C/W, junction to ambient, or 30°C/W, junction to case. The thermal resistance of the dual-in-line package is 100°C/W, junction to ambient.

Note 2: For supply voltages less than ± 15 V, the absolute maximum input voltage is equal to the supply voltage.

Note 3: These specifications apply for $\pm5V \le V_S \le \pm20V$ and $-55^\circ\text{C} \le T_A \le \pm125^\circ\text{C}$ for the LM107 or $-25^\circ\text{C} \le T_A + 85^\circ\text{C}$ for the LM207, and $0^\circ\text{C} \le T_A \le \pm70^\circ\text{C}$ and $\pm5V \le V_S \le \pm15V$ for the LM307 unless otherwise specified.

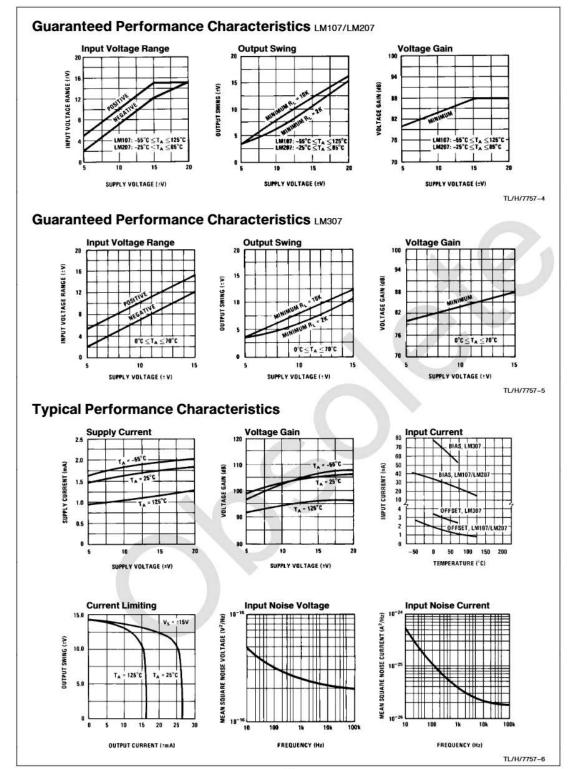
Note 4: Refer to RETS107X for LM107H and LM107J military specifications.

Schematic Diagram*

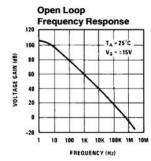


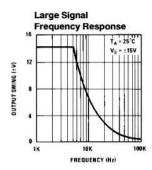
*Pin connections shown are for metal can.

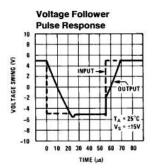
TL/H/7757-1



Typical Performance Characteristics (Continued)

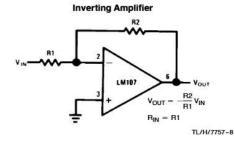


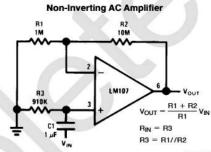




TL/H/7757-7

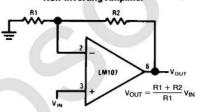
Typical Applications**





TL/H/7757-10

Non-Inverting Amplifier

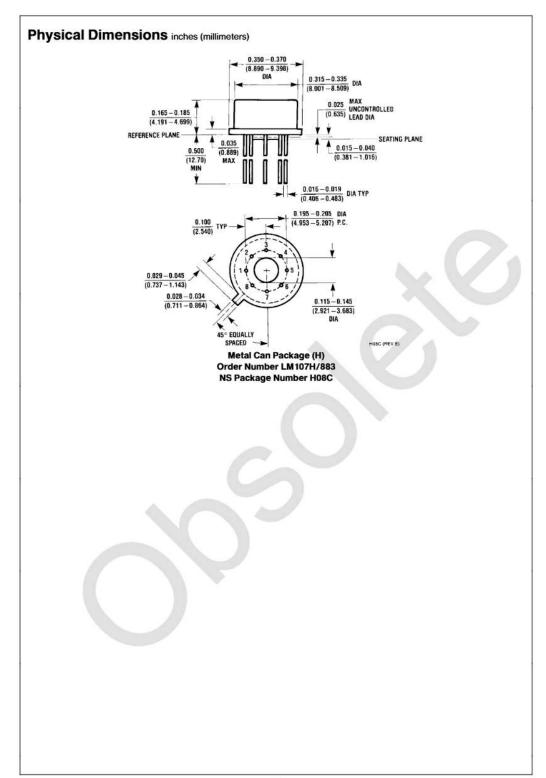


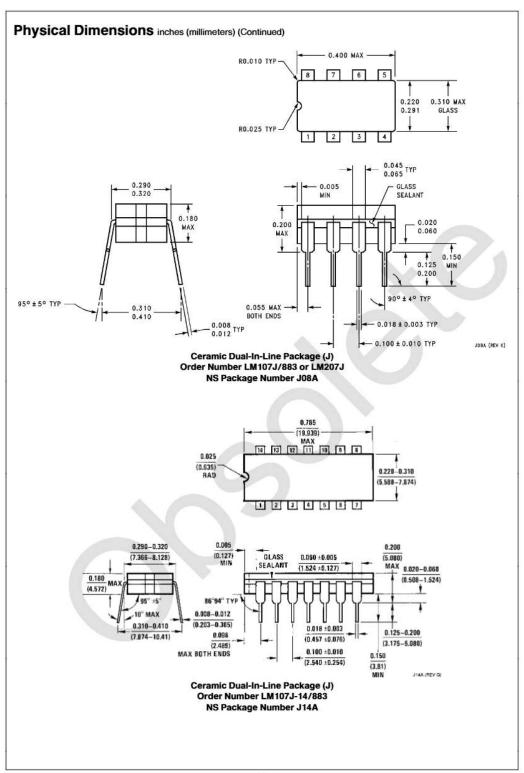
TL/H/7757-9

^{**}Pin connections shown are for metal can.

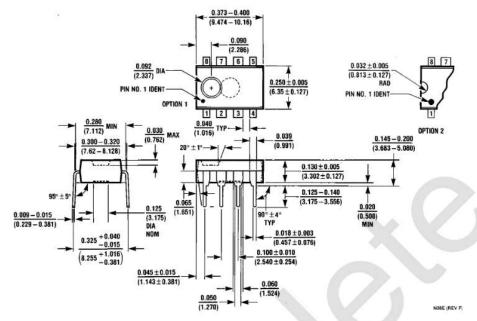
Typical Applications** (Continued) Turntable Notch Filter LM310 TL/H/7757-11 Differential Input Instrumentation Amplifier INPUT LM307 OUTPUT LM310 TL/H/7757-12 **Pin connections shown are for metal can.







Physical Dimensions inches (millimeters) (Continued)



Molded Dual-In-Line Package (N) Order Number LM307N NS Package Number N08E

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